## BGA622L7

Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

**Small Signal Discretes** 



#### Edition 2008-04-14

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# BGA622L7, Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection Revision History: 2008-04-14, Rev. 2.2 Previous Version: 2006-05-19 Page Subjects (major changes since last revision) All Document layout change

#### **Trademarks**

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Data Sheet 3 Rev. 2.2, 2008-04-14



Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

## 1 Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

#### **Feature**

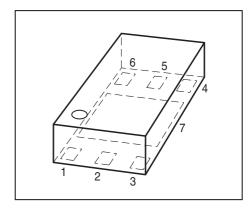
High gain

 $|S_{21}|^2$  = 17.5 dB at 1.575 GHz

 $|S_{21}|^2$  = 16.8 dB at 1.9 GHz

 $|S_{21}|^2$  = 16.2 dB at 2.14 GHz

- Low noise figure, NF = 0.95 dB at 1.575 GHz
- · Operating frequency range 0.5 6 GHz
- Typical supply voltage: 2.75 V
- On/Off-Switch
- Output-match on chip, input pre-matched
- Low external part count
- Tiny TSLP-7-1 leadless package
- 70 GHz f<sub>T</sub> Silicon Germanium technology
- 2 kV HBM ESD protection (Pin-to-Pin)
- Pb-free (RoHS compliant) package



**TSLP-7-1** 



#### **Applications**

LNA for GSM, GPS, DCS, PCS, UMTS, Bluethooth, ISM and WLAN

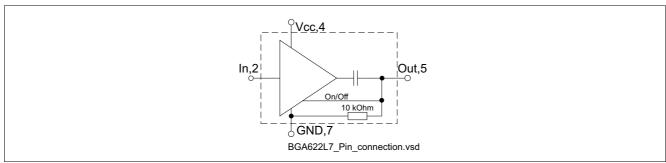


Figure 1 Pin connection

#### **Description**

The BGA622L7 is a wide band low noise amplifier, based on Infineon Technologies' Silicon Germanium Technology B7HF. The out-pin is simultaneously used for RF out and On/Off switch. This functionality can be accessed using a RF-Choke at the Out pin, where a DC level of 0 V or an open switches the device on and a DC level of  $V_{\rm CC}$  switches off, it provides an insertion loss of 26 dB together with a high  $IIP_3$  up to 24 dBm at GPS frequencies.

Туре	Package	Marking		
BGA622L7	TSLP-7-1	BX		

Note: **ESD:** Electrostatic discharge sensitive device, observe handling precaution



**Maximum Ratings** 

### 2 Maximum Ratings

Table 1 Maximum ratings

3.5 4 0.1	V V
0.1	mΛ
	mA
1	mA
10	mA
6	dBm
35	mW
150	°C
-65 150	°C
-65 150	°C
2000	V
	-65 150 -65 150

<sup>1)</sup>  $T_{\rm S}$  is measured on the ground lead at the soldering point

Note: All Voltages refer to GND-Node

#### Thermal resistance

Table 2 Thermal resistance

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{thJS}$	240	K/W

<sup>1)</sup> For calculation of  $R_{\mathrm{thJA}}$  please refer to Application Note Thermal Resistance

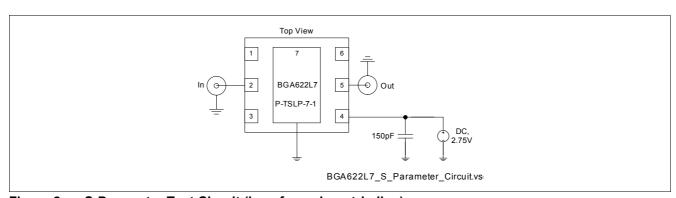


Figure 2 S-Parameter Test Circuit (loss-free microstrip line)



**Electrical Characteristics** 

#### 3 Electrical Characteristics

# 3.1 Electrical Characteristics at $T_{\rm A}$ = 25 °C (measured according to Figure 2) $V_{\rm CC}$ = 2.75 V, Frequency = 1.575 GHz, unless otherwise specified

**Table 3** Electrical Characteristics

Parameter	Symbol Values			S	Unit	Note /
		Min.	Тур.	Max.		<b>Test Condition</b>
Insertion power gain	$ S_{21} ^2$		17.5		dB	
Insertion power gain (Off-State)	$ S_{21} ^2$		-26		dB	
Input return loss (On-State)	$RL_{\sf in}$		5		dB	
Output return loss (On-State)	$RL_{out}$		12		dB	
Noise figure ( $Z_{\rm S}$ = 50 $\Omega$ )	$F_{50\Omega}$		0.95		dB	
Input third order intercept point <sup>1)</sup> (On-State)	$IIP_3$		-2		dBm	$\Delta f$ = 1 MHz, $P_{\text{IN}}$ = -28 dBm
Input third order intercept point <sup>1)</sup> (Off - State)	$IIP_3$		24		dBm	$\Delta f$ = 1 MHz, $P_{\text{IN}}$ = -8 dBm
Input power at 1 dB gain compression	$P_{ ext{-1dB}}$		-20		dBm	
Total device off current	$I_{tot\text{-off}}$		260		μΑ	$V_{\rm CC}$ = 2.75 V, $V_{\rm out}$ = $V_{\rm CC}$
Total device on current	$I_{tot ext{-on}}$		5.8		mA	$V_{\rm CC}$ = 2.75 V
On / Off switch control voltage	$V_{on}$	0		0.8	V	$V_{\rm CC}$ = 2.75 V ON-Mode: $V_{\rm out}$ = $V_{\rm on}$
	$V_{ m off}$	2.0		3.5	V	$V_{\rm CC}$ = 2.75 V OFF-Mode: $V_{\rm out}$ = $V_{\rm off}$

<sup>1)</sup>  $IP_3$  values depends on termination of all intermodulation frequency components. Termination used for this measurement is 50  $\Omega$  from 0.1 to 6 GHz



**Electrical Characteristics** 

# 3.2 Electrical Characteristics at $T_{\rm A}$ = 25 °C (measured according to Figure 2) $V_{\rm CC}$ = 2.75 V, Frequency = 2.14 GHz, unless otherwise specified

**Table 4** Electrical Characteristics

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		<b>Test Condition</b>
Insertion power gain	$ S_{21} ^2$		16.2		dB	
Insertion power gain (Off-State)	$ S_{21} ^2$		-23		dB	
Input return loss (On-State)	$RL_{\sf in}$		6		dB	
Output return loss (On-State)	$RL_{out}$		12		dB	
Noise figure ( $Z_{\rm S}$ = 50 $\Omega$ )	$F_{50\Omega}$		1.05		dB	
Input third order intercept point <sup>1)</sup> (On-State)	$IIP_3$		0		dBm	$\Delta f$ = 1 MHz, $P_{\text{IN}}$ = -28 dBm
Input third order intercept point <sup>1)</sup> (Off-State)	$IIP_3$		22		dBm	$\Delta f$ = 1 MHz, $P_{\text{IN}}$ = -8 dBm
Input power at 1 dB gain compression	$P_{ ext{-1dB}}$		-16		dBm	

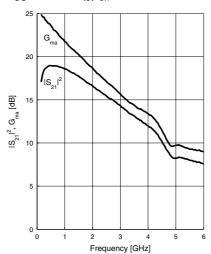
<sup>1)</sup>  $IP_3$  values depends on termination of all intermodulation frequency components. Termination used for this measurement is 50  $\Omega$  from 0.1 to 6 GHz



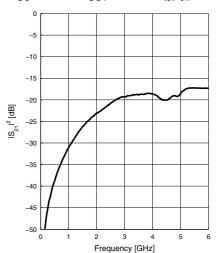
**Measured Parameters** 

#### 4 Measured Parameters

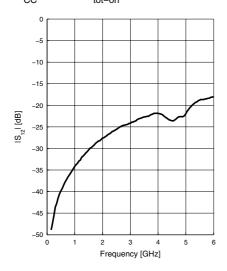
Power Gain 
$$|S_{21}|^2$$
,  $G_{ma} = f(f)$   
 $V_{CC} = 2.75V$ ,  $I_{tot-on} = 5.8mA$ 



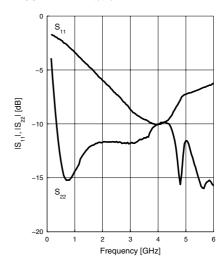
Off Gain 
$$IS_{21}^2I^2 = f(f)$$
  
 $V_{CC} = 2.75V, V_{OUT} = 2.75V, I_{tot-off} = 0.3mA$ 



Reverse Isolation 
$$|S_{12}| = f(f)$$
  
 $V_{CC} = 2.75V$ ,  $I_{tot-on} = 5.8mA$ 



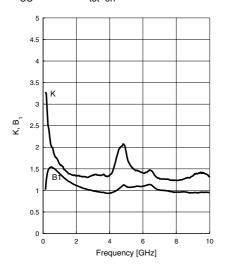
$$\begin{aligned} & \textbf{Matching} \ |S_{11}|, \ |S_{22}| = f(f) \\ & V_{CC} = 2.75V, \ I_{tot-on} = 5.8 \text{mA} \end{aligned}$$





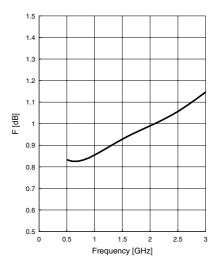
#### **Measured Parameters**

Stability K, B<sub>1</sub> = f(f)  
$$V_{CC} = 2.75V$$
,  $I_{tot-on} = 5.8mA$ 

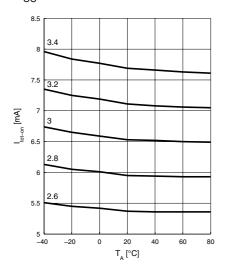


#### Noise Figure F = f(f)

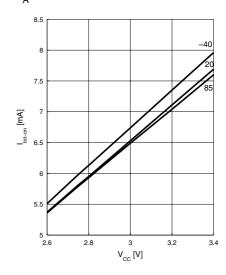
$$V_{CC} = 2.75V$$
,  $I_{tot-on} = 5.8mA$ ,  $Z_{S} = 50\Omega$ 



Device Current I
$$_{tot-on} = f(T_A, V_{CC})$$
  
V $_{CC} = parameter in V$ 



Device Current 
$$I_{tot-on} = f(V_{CC}, T_A)$$
  
  $T_A = parameter in °C$ 





**Package Information** 

## 5 Package Information

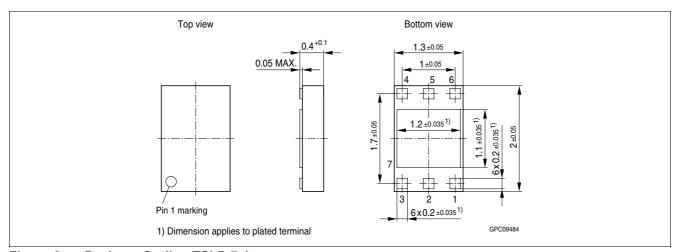


Figure 3 Package Outline TSLP-7-1

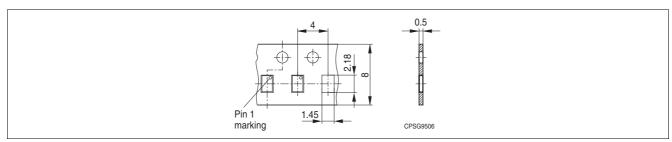


Figure 4 Tape for TSLP-7-1